

# GaAs INTEGRATED CIRCUIT $\mu PG2179TB$

# L, S-BAND MEDIUM POWER SPDT SWITCH

#### DESCRIPTION

The μPG2179TB is a GaAs MMIC L, S-band SPDT (Single Pole Double Throw) switch for mobile phone and other L, S-band applications. This device operates with dual control voltages of 2.5 to 5.3 V. This device can operate from 0.05 to 3.0 GHz, with low insertion loss and high isolation.

This device is housed in a 6-pin super minimold package, and is suitable for high-density surface mounting.

#### ★ FEATURES

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| <ul> <li>Switch control voltage</li> </ul> | : V <sub>cont (H)</sub> = 2.5 to 5.3 V (3.0 V TYP.)  |
|--|--|
| e men ee men ge                            |  |
|  | : $V_{\text{cont}(L)} = -0.2 \text{ to } +0.2 \text{ V} (0 \text{ V TYP.})$                          |
| <ul> <li>Low insertion loss</li> </ul>     | : Lins1 = 0.25 dB TYP. @ f = 0.05 to 1.0 GHz, Vcont (H) = 3.0 V, Vcont (L) = 0 V                     |
|  | : Lins2 = 0.30 dB TYP. @ f = 1.0 to 2.0 GHz, Vcont (H) = 3.0 V, Vcont (L) = 0 V                      |
|  | : Lins3 = 0.35 dB TYP. @ f = 2.0 to 2.5 GHz, Vcont (H) = 3.0 V, Vcont (L) = 0 V                      |
|  | : Lins4 = 0.40 dB TYP. @ f = 2.5 to 3.0 GHz, Vcont (H) = 3.0 V, Vcont (L) = 0 V                      |
| <ul> <li>High isolation</li> </ul>         | : ISL1 = 27 dB TYP. @ f = 0.05 to 2.0 GHz, Vcont (H) = 3.0 V, Vcont (L) = 0 V                        |
|  | : ISL2 = 24 dB TYP. @ f = 2.0 to 3.0 GHz, V <sub>cont (H)</sub> = 3.0 V, V <sub>cont (L)</sub> = 0 V |
| <ul> <li>Power handling</li> </ul>         | : Pin (0.1 dB) = +29.0 dBm TYP. @ f = 0.5 to 3.0 GHz, $V_{cont (H)} = 3.0 V$ , $V_{cont (L)} = 0 V$  |
|  | : Pin (1 dB) = +32.0 dBm TYP. @ f = 0.5 to 3.0 GHz, $V_{cont (H)} = 3.0 V$ , $V_{cont (L)} = 0 V$    |
|  |  |

+ High-density surface mounting : 6-pin super minimold package ( $2.0 \times 1.25 \times 0.9$  mm)

#### **APPLICATIONS**

- · L, S-band digital cellular or cordless telephone
- PCS, W-LAN, WLL and Bluetooth<sup>™</sup> etc.

#### ★ ORDERING INFORMATION

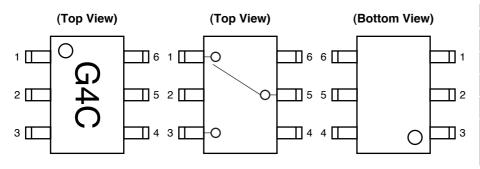
| Part Number            | Package              | Marking | Supplying Form  |
|------------------------|----------------------|---------|---|
| <i>µ</i> РG2179TB-E4-A | 6-pin super minimold | G4C     | <ul> <li>Embossed tape 8 mm wide</li> <li>Pin 4, 5, 6 face the perforation side of the tape</li> <li>Qty 3 kpcs/reel</li> </ul> |

**Remark** To order evaluation samples, contact your nearby sales office. Part number for sample order: *µ*PG2179TB-A

Caution Observe precautions when handling because these devices are sensitive to electrostatic discharge.

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#### PIN CONNECTIONS AND INTERNAL BLOCK DIAGRAM



| Dia Ma  | Dia Mara |
|---------|----------|
| Pin No. | Pin Name |
| 1       | OUTPUT1  |
| 2       | GND      |
| 3       | OUTPUT2  |
| 4       | Vcont2   |
| 5       | INPUT    |
| 6       | Vcont1   |

#### TRUTH TABLE

| Vcont1 | Vcont2 | INPUT-OUTPUT1 | INPUT-OUTPUT2 |
|--------|--------|---------------|---------------|
| Low    | High   | ON            | OFF           |
| High   | Low    | OFF           | ON            |

#### ABSOLUTE MAXIMUM RATINGS (TA = +25°C, unless otherwise specified)

| Parameter                     | Symbol | Ratings     | Unit |
|-------------------------------|--------|-------------|------|
| Switch Control Voltage        | Vcont  | 6.0 Note    | V    |
| Input Power                   | Pin    | +33         | dBm  |
| Operating Ambient Temperature | TA     | -45 to +85  | °C   |
| Storage Temperature           | Tstg   | –55 to +150 | °C   |

**\*** Note  $|V_{cont1} - V_{cont2}| \le 6.0 V$ 

#### **RECOMMENDED OPERATING RANGE (TA = +25°C, unless otherwise specified)**

|   | Parameter                  | Symbol    | MIN. | TYP. | MAX. | Unit |
|---|----------------------------|-----------|------|------|------|------|
| * | Switch Control Voltage (H) | Vcont (H) | 2.5  | 3.0  | 5.3  | V    |
|   | Switch Control Voltage (L) | Vcont (L) | -0.2 | 0    | 0.2  | V    |

#### **★** ELECTRICAL CHARACTERISTICS

(TA = +25°C, V<sub>cont</sub> (H) = 3.0 V, V<sub>cont</sub> (L) = 0 V, DC blocking capacitors = 100 pF, unless otherwise specified)

| Parameter                    | Symbol       | Test Conditions                      | MIN.  | TYP.  | MAX. | Unit |
|------------------------------|--------------|--------------------------------------|-------|-------|------|------|
| Insertion Loss 1             | Lins1        | f = 0.05 to 1.0 GHz <sup>Note1</sup> | -     | 0.25  | 0.45 | dB   |
| Insertion Loss 2             | Lins2        | f = 1.0 to 2.0 GHz                   | -     | 0.30  | 0.50 | dB   |
| Insertion Loss 3             | Lins3        | f = 2.0 to 2.5 GHz                   | -     | 0.35  | 0.55 | dB   |
| Insertion Loss 4             | Lins4        | f = 2.5 to 3.0 GHz                   | -     | 0.40  | 0.60 | dB   |
| Isolation 1                  | ISL1         | f = 0.05 to 2.0 GHz <sup>Note1</sup> | 23    | 27    | -    | dB   |
| Isolation 2                  | ISL2         | f = 2.0 to 3.0 GHz                   | 20    | 24    | -    | dB   |
| Input Return Loss            | RLin         | f = 0.05 to 3.0 GHz <sup>Note1</sup> | 15    | 20    | -    | dB   |
| Output Return Loss           | RLout        | f = 0.05 to 3.0 GHz <sup>Note1</sup> | 15    | 20    | -    | dB   |
| 0.1 dB Loss Compression      | Pin (0.1 dB) | f = 2.0 GHz                          | +25.5 | +29.0 | -    | dBm  |
| Input Power <sup>Note2</sup> |              | f = 2.5 GHz                          | +25.5 | +29.0 | -    | dBm  |
|                              |              | f = 0.5 to 3.0 GHz                   | -     | +29.0 | -    | dBm  |
| Switch Control Current       | Icont        | No signal                            | -     | 4     | 20   | μA   |
| Switch Control Speed         | tsw          | 50%CTL to 90/10%RF                   | -     | 50    | 500  | ns   |

Note1. DC blocking capacitor = 1 000 pF at f = 0.05 to 0.5 GHz.

2. Pin (0.1 dB) is the measured input power level when the insertion loss increases 0.1 dB more than that of linear range.

#### **\*** STANDARD CHARACTERISTICS FOR REFERENCE

(TA = +25°C, V<sub>cont</sub> (H) = 3.0 V, V<sub>cont</sub> (L) = 0 V, DC blocking capacitors = 100 pF, unless otherwise specified)

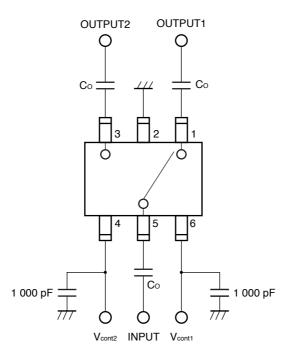
| Parameter                           | Symbol     | Test Conditions             | MIN. | TYP.  | MAX. | Unit |
|-------------------------------------|------------|-----------------------------|------|-------|------|------|
| 1 dB Loss Compression               | Pin (1 dB) | f = 0.5 to 3.0 GHz          | -    | +32.0 | -    | dBm  |
| Input Power <sup>Note</sup>         |            |                             |      |       |      |      |
| 3rd Order Intermodulation Intercept | IIP₃       | f = 0.5 to 3.0 GHz, 2 tone, | -    | +60.0 | -    | dBm  |
| Point                               |            | 5 MHz spicing               |      |       |      |      |

Note Pin (1 dB) is the measured input power level when the insertion loss increases 1 dB more than that of linear range.

**★** Caution When using this IC, a DC coupling capacitor must be externally attached to the I/O pins.

A DC coupling capacitor with a capacitance of 100 pF or lower is recommended when using a frequency of 0.5 GHz or higher, and one with a capacitance of 1,000 pF is recommended when using a frequency of less than 0.5 GHz. The ideal value changes depending on the frequency and bandwidth used, so select a capacitor with a suitable capacitance according to the usage conditions.

## ★ EVALUATION CIRCUIT



Remark Co : 0.05 to 0.5 GHz 1 000 pF 0.5 to 3.0 GHz 100 pF

The application circuits and their parameters are for reference only and are not intended for use in actual design-ins.

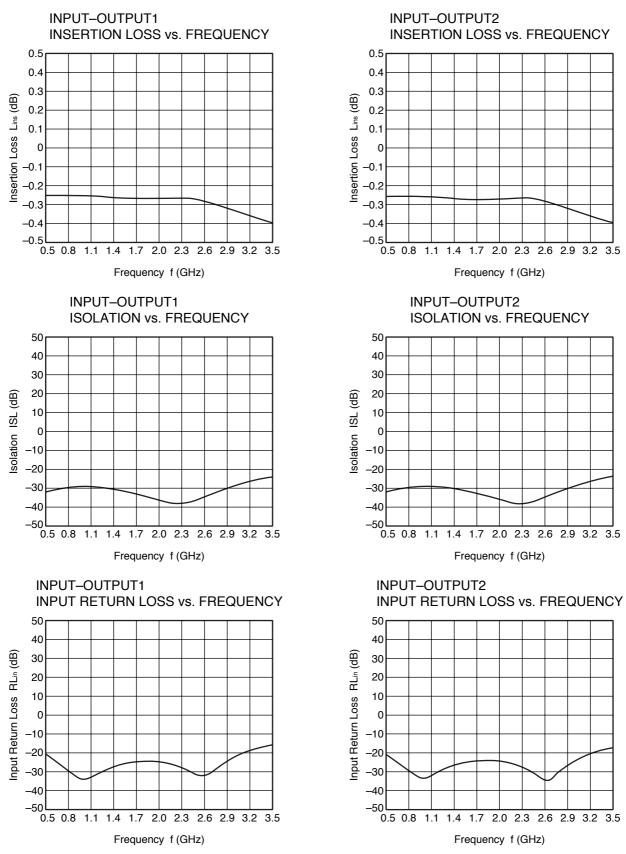
- Vcont2 6pin SMM SPDT SW 0 0 Vc2 0 0 0 OUTPUT2 OUT 2 0 0 0 ° C2 С 0 0 C1 0 0 0 0 G4C INPUT 0 C3 C1 0 0 ° C1 IN 0 0 0 0 0 0 0 OUT 1 OUTPUT1 0 0 0 Vc1 0 0 0 Vcont1
- ★ ILLUSTRATION OF THE TEST CIRCUIT ASSEMBLED ON EVALUATION BOARD

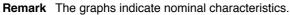
#### USING THE NEC EVALUATION BOARD

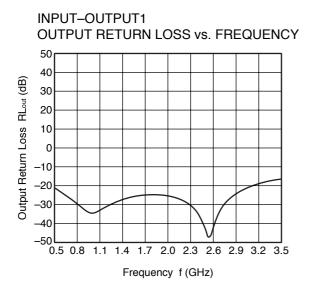
| Symbol     | Values   |
|------------|----------|
| C1, C2, C3 | 100 pF   |
| C4, C5     | 1 000 pF |

#### **TYPICAL CHARACTERISTICS**

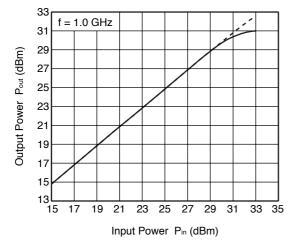
★ (TA = +25°C, Vcont (H) = 3.0 V, Vcont (L) = 0 V, DC blocking capacitors = 100 pF, unless otherwise specified)





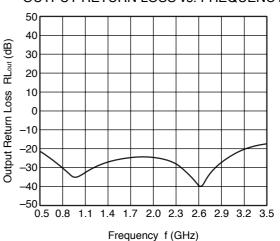


OUTPUT POWER vs. INPUT POWER

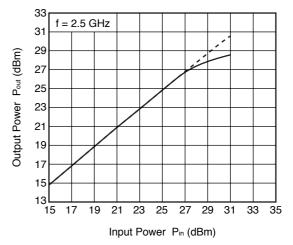


Remark The graphs indicate nominal characteristics.

INPUT-OUTPUT2 OUTPUT RETURN LOSS vs. FREQUENCY

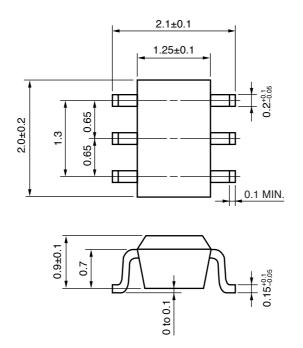


**OUTPUT POWER vs. INPUT POWER** 



### PACKAGE DIMENSIONS

## 6-PIN SUPER MINIMOLD (UNIT: mm)



#### **RECOMMENDED SOLDERING CONDITIONS**

This product should be soldered and mounted under the following recommended conditions. For soldering methods and conditions other than those recommended below, contact your nearby sales office.

| Soldering Method | Soldering Conditions   |   | Condition Symbol |
|------------------|--|---|------------------|
| Infrared Reflow  | Peak temperature (package surface temperature)<br>Time at peak temperature<br>Time at temperature of 220°C or higher<br>Preheating time at 120 to 180°C<br>Maximum number of reflow processes<br>Maximum chlorine content of rosin flux (% mass) | : 260°C or below<br>: 10 seconds or less<br>: 60 seconds or less<br>: 120±30 seconds<br>: 3 times<br>: 0.2%(Wt.) or below | IR260            |
| VPS              | Peak temperature (package surface temperature)<br>Time at temperature of 200°C or higher<br>Preheating time at 120 to 150°C<br>Maximum number of reflow processes<br>Maximum chlorine content of rosin flux (% mass)                             | : 215°C or below<br>: 25 to 40 seconds<br>: 30 to 60 seconds<br>: 3 times<br>: 0.2%(Wt.) or below                         | VP215            |
| Wave Soldering   | Peak temperature (molten solder temperature)<br>Time at peak temperature<br>Preheating temperature (package surface temperature)<br>Maximum number of flow processes<br>Maximum chlorine content of rosin flux (% mass)                          | : 260°C or below<br>: 10 seconds or less<br>: 120°C or below<br>: 1 time<br>: 0.2%(Wt.) or below                          | WS260            |
| Partial Heating  | Peak temperature (pin temperature)<br>Soldering time (per side of device)<br>Maximum chlorine content of rosin flux (% mass)   | : 350°C or below<br>: 3 seconds or less<br>: 0.2%(Wt.) or below   | HS350            |

Caution Do not use different soldering methods together (except for partial heating).

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M8E 00.4-0110

| Caution GaAs Products | This product uses gallium arsenide (GaAs).<br>GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe<br>the following points.   |
|-----------------------|--|
|                       | <ul> <li>Follow related laws and ordinances when disposing of the product. If there are no applicable laws<br/>and/or ordinances, dispose of the product as recommended below.</li> </ul>                          |
|                       | <ol> <li>Commission a disposal company able to (with a license to) collect, transport and dispose of<br/>materials that contain arsenic and other such industrial waste materials.</li> </ol>                      |
|                       | <ol><li>Exclude the product from general industrial waste and household garbage, and ensure that the<br/>product is controlled (as industrial waste subject to special control) up until final disposal.</li></ol> |
|                       | Do not burn, destroy, cut, crush, or chemically dissolve the product.  |
|                       | Do not lick the product or in any way allow it to enter the mouth.   |

#### ▶ For further information, please contact

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